

Integrated Load Switch FDC6330L

Description

This device is particularly suited for compact power management in portable electronic equipment where 3 V to 20 V input and 2.3 A output current capability are needed. This load switch integrates a small N-Channel power MOSFET (Q1) which drives a large P-Channel power MOSFET (Q2) in one tiny SUPERSOT $^{\text{\tiny M}}$ -6 package.

Features

- $V_{DROP} = 0.20 \text{ V}$ @ $V_{IN} = 12 \text{ V}$, $I_L = 2.5 \text{ A}$, $R_{(on)} = 0.08 \Omega$
- $V_{DROP} = 0.20 \text{ V}$ @ $V_{IN} = 5 \text{ V}$, $I_L = 1.6 \text{ A}$, $R_{(on)} = 0.125 \Omega$
- Control MOSFET (Q1) Includes Zener Protection for ESD Ruggedness (> 6 kV Human Body Model)
- High Performance POWERTRENCH® Technology for Extremely Low On–Resistance
- SUPERSOT-6 Package Design Using Copper Lead Frame for Superior Thermal and Electrical Capabilities
- This is a Pb-Free and Halide Free Device

Application

- Power Management
- Load Actuation

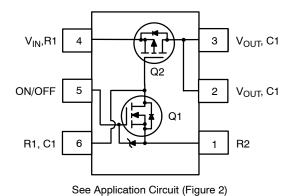


Figure 1.

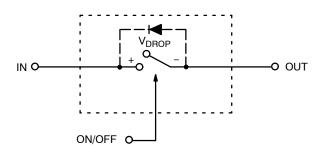


Figure 2. Equivalent Circuit



TSOT-23-6 CASE 419BL

MARKING DIAGRAM



&E = Designates Space

&Y = Binary Calendar Year Coding Scheme

&. = Pin One Dot

330 = Specific Device Code

&G = Date Code

ORDERING INFORMATION

Device	Package	Shipping [†]
FDC6330L	TSOT-23-6 (Pb-Free)	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

ABSOLUTE MAXIMUM RATINGS T_A = 25°C unless otherwise noted

Symbol	Parameter	Value	Unit
V _{IN}	Input Voltage Range (Note 1)	3 – 20	V
V _{ON/OFF}	On/Off Voltage Range	1.5 – 8	V
I _D	Load Current - Continuous (Note 2)	2.3	Α
	Load Current - Pulsed	10	
P _D	Maximum Power Dissipation (Note 1)	0.7	W
T _J , T _{STG}	Operating and Storage Temperature Range	-55 to 150	°C
ESD	ESD Electrostatic Discharge Rating MIL–STD–883D Human Body Model (100 pF / 1500 Ω)		kV

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS T_A = 25°C unless otherwise noted

Symbol	Parameter	Value	Unit
$R_{ heta JA}$	Thermal Resistance, Junction-to-Ambient (Note 2)	180	°C/W
$R_{ heta JC}$	Thermal Resistance, Junction-to-Case (Note 2)	60	°C/W

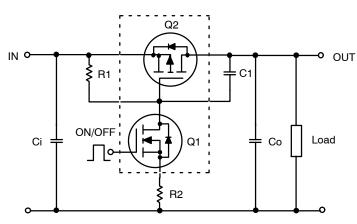
ELECTRICAL CHARACTERISTICS T_Δ = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
OFF CHARACTERISTICS						
I _{FL}	Leakage Current	V _{IN} = 20 V, V _{ON/OFF} = 0 V	-	-	1	μΑ
ON CHARACT	TERISTICS (Note 3)					
V_{DROP}	Conduction Voltage	V _{IN} = 12 V, V _{ON/OFF} = 3.3 V, I _L = 2.5 A	-	_	0.2	V
		V _{IN} = 5 V, V _{ON/OFF} = 3.3 V, I _L = 1.6 A	-	-	0.2	
R _{DS(on)}	Q ₂ - Static On-Resistance	$V_{GS} = -12 \text{ V}, I_D = -2.3 \text{ A}$	-	0.054	0.08	Ω
		$V_{GS} = -5 \text{ V}, I_D = -1.9 \text{ A}$	-	0.081	0.125	
ال	Load Current	V _{DROP} = 0.2 V, V _{IN} = 12 V, V _{ON/OFF} = 3.3 V	2.5	_	_	Α
		V _{DROP} = 0.2 V, V _{IN} = 5 V, V _{ON/OFF} = 3.3 V	1.6	_	_	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

NOTES:

- 1. Range of V_{in} can be up to 30 V, but R_1 and R_2 must be scaled such that V_{GS} of Q2 does not exceed 20 V.
- R_{θ,JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{θ,JC} is guaranteed by design while R_{θ,JA} is determined by the user's board design.
- 3. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2.0%.



External Component Recommendation:

For applications where Co \leq 1 μ F.

For slew rate control, select R2 in the range of 1k – 4.7 k Ω . For additional in–rush current control, C1 \leq 1000 pF can be added.

Select R1 so that the R1/R2 ratio ranges from 10–100. R1 is required to turn Q2 off.

Figure 3. FDC6330L Load Switch Application

FDC6330L

TYPICAL CHARACTERISTICS

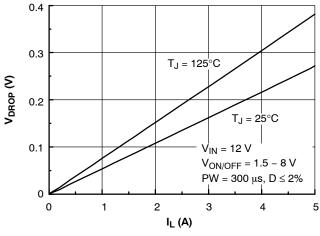


Figure 4. Conduction Voltage Drop Variation with Load Current

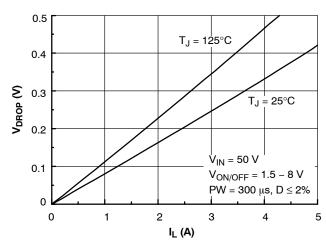


Figure 5. Conduction Voltage Drop Variation with Load Current

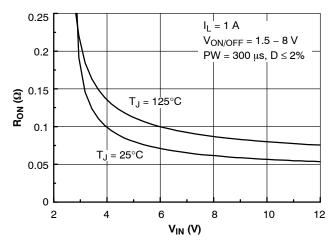


Figure 6. On-Resistance Variation with Input Voltage

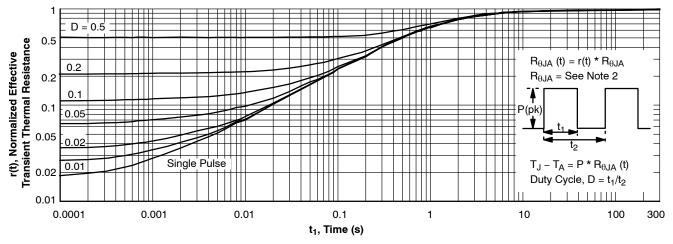


Figure 7. Transient Thermal Response Curve

NOTE: Thermal characterization performed on the conditions described in Note 2.

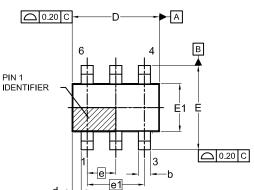
Transient thermal response will change depending on the circuit board design.

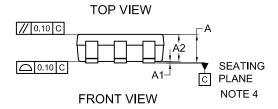
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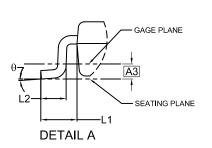


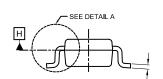
TSOT23 6-Lead CASE 419BL **ISSUE A**

DATE 31 AUG 2020









SIDE VIEW

SYMM €
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LAND PATTERN RECOMMENDATION

*FOR ADDITIONAL INFORMATION ON OUR PB-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ON SEMICONDUCTOR SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.



- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009.
- CONTROLLING DIMENSION: MILLIMETERS
 DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH,
 PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.25MM PER END. DIMENSIONS D AND E1 ARE DETERMINED AT DATUM H.
- 4. SEATING PLANE IS DEFINED BY THE TERMINALS. "A1" IS DEFINED AS THE DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT ON THE PACKAGE BODY.

DIM	l N	IILLIMET	ERS
D ₁ ,v,	MIN.	NOM.	MAX.
Α	0.90	1.00	1.10
A1	0.00	0.05	0.10
A2	0.70	0.85	1.00
А3	0.25 BSC		
b	0.25	0.38	0.50
С	0.10	0.18	0.26
D	2.80	2.95	3.10
d	0.30 REF		
Е	2.50	2.75	3.00
E1	1.30	1.50	1.70
е	0.95 BSC		
e1	1.90 BSC		
L1	0.60 REF		
L2	0.20	0.40	0.60
θ	0°	-	10°

GENERIC MARKING DIAGRAM*



XXX = Specific Device Code

= Date Code Μ

= Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present. Some products may not follow the Generic Marking.

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